Title: Flip Chip Adaptor Package for Bare Die

Inventor: Walter L. Moden

Serial No. 09/699,537

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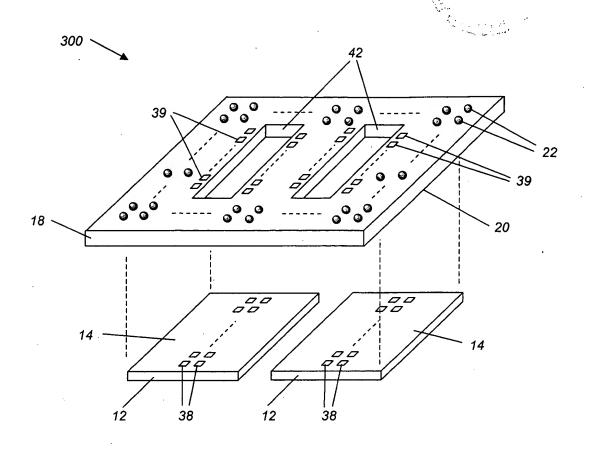


Fig. 3A